

# 2.1 Structure and functions of MOSFET

Principle of MOSFET

## 2.1.1 PN junction

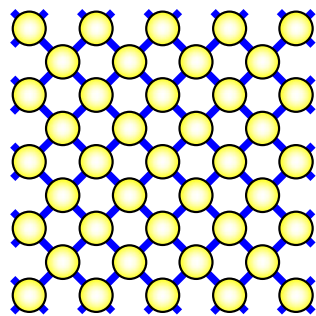
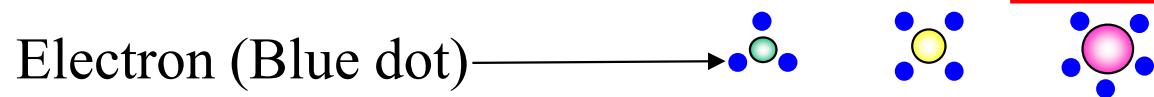
# Electrical conductivity control 1

Periodic table

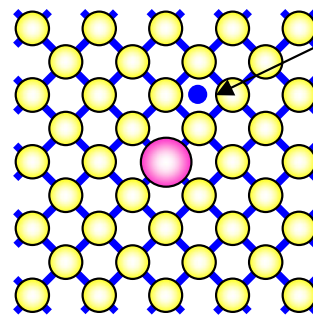
	III	IV	V	
	B	C	N	
	Al	Si	P	
	Ga	Ge	As	
	In	Sn	Sb	

\* A free electron (自由電子) is not bound to an atom.

Free Electron (\*)

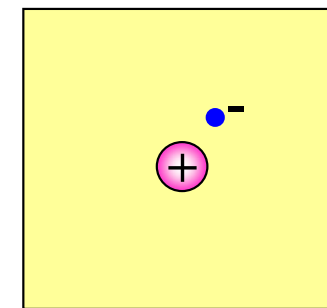


Crystal of Si



P(Phosphorous)-doped Si (\*)

\* Doping: Introducing an impurity



Simplified sketch

# Electrical conductivity control 2

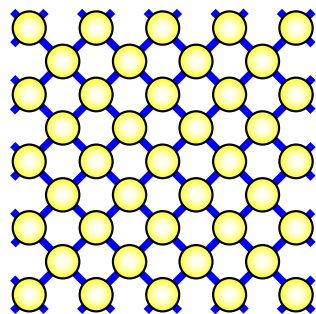
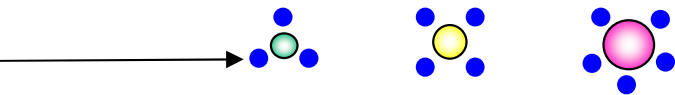
Periodic table

	III	IV	V	
	B	C	N	
	Al	Si	P	
	Ga	Ge	As	
	In	Sn	Sb	

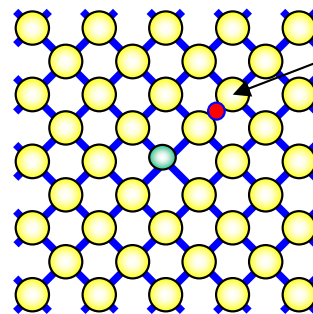
\* A hole is an ionized Si atom by transferring a valence electron to an impurity.

Hole (\*)

Electron (Blue dot)

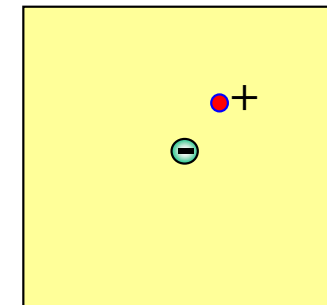


Crystal of Si



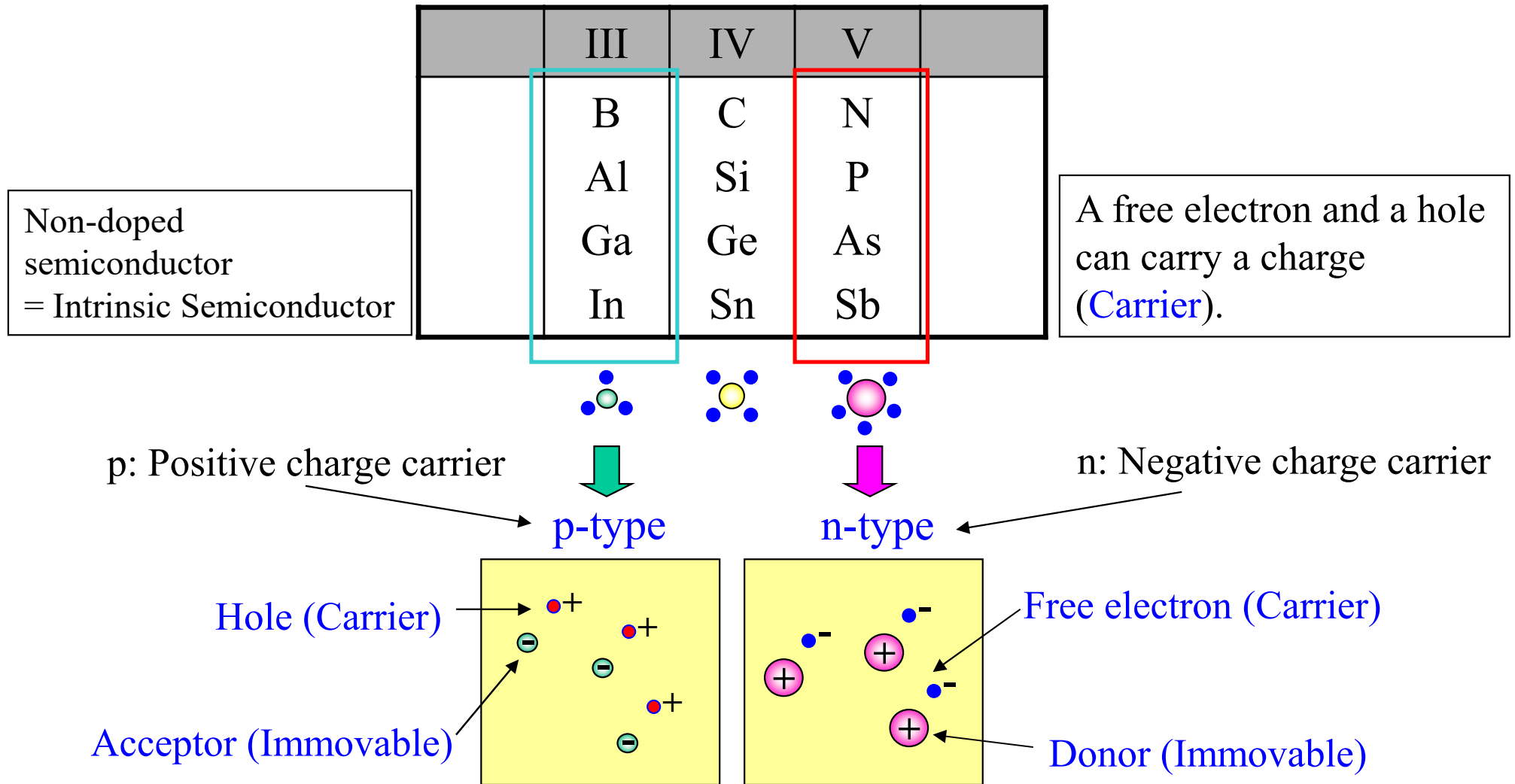
B(Boron)-doped Si (\*)

\* Doping: Introducing an impurity



Simplified sketch

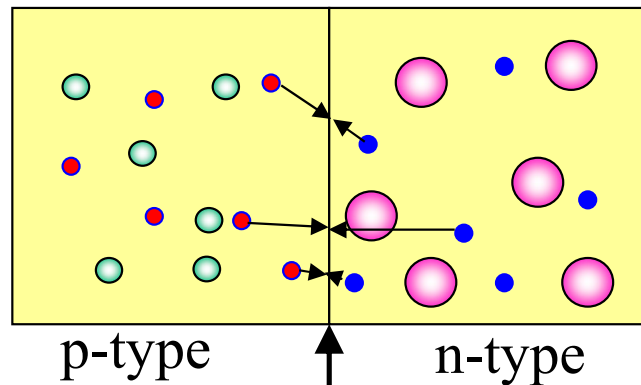
# Conductivity type of semiconductor



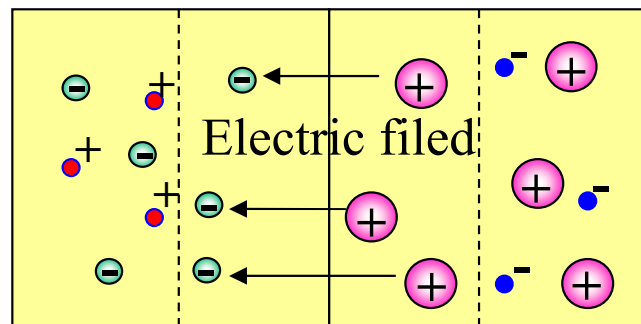
The number of carriers equals to the number of accepters or donors.

# Electric field of pn junction

A pn junction is formed at a boundary between the p-type semiconductor and the n-type semiconductor.

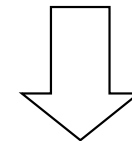


**pn junction (pn接合)**



**Depletion layer (空乏層)**

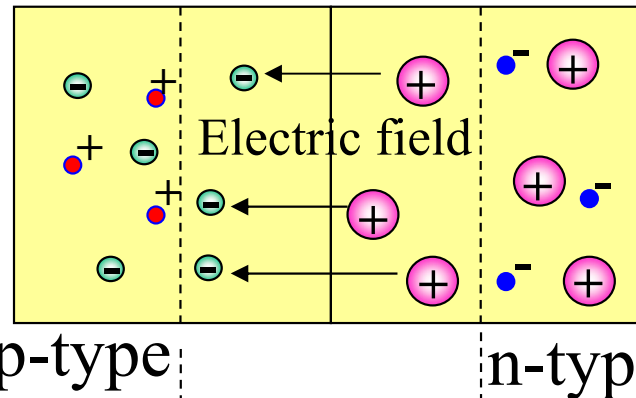
Free electrons and holes are recombined in the vicinity of the pn junction, and a depletion layer of carriers are formed.



The ionized donors and acceptors forms the built-in electric field in the depletion layer.

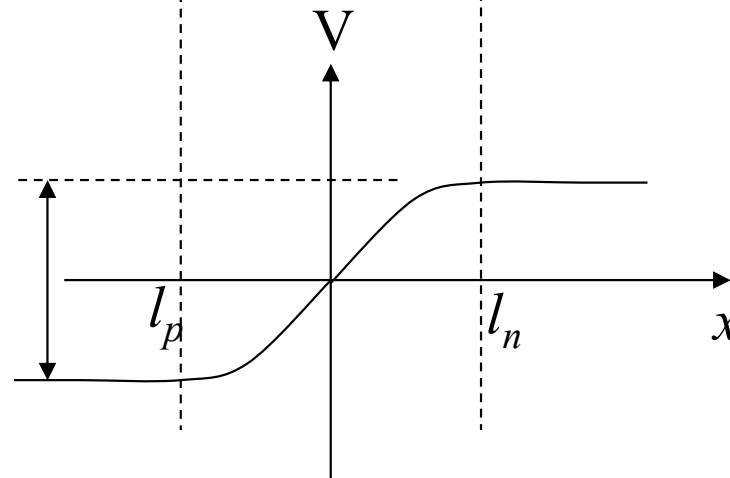
$$\frac{dE}{dx} = \frac{\rho}{\epsilon_0 \epsilon_{Si}} \quad (\text{Gauss's law})$$

# Voltage of pn junction



The built-in voltage  $V_B$  is generated by the built-in electric field.

Built-in voltage  $V_B$   
(内蔵電位)



$$E = -\frac{dV}{dx}$$

$$dV = -E \cdot dx$$

$$V_B = -\int_{l_p}^n E \cdot dx$$

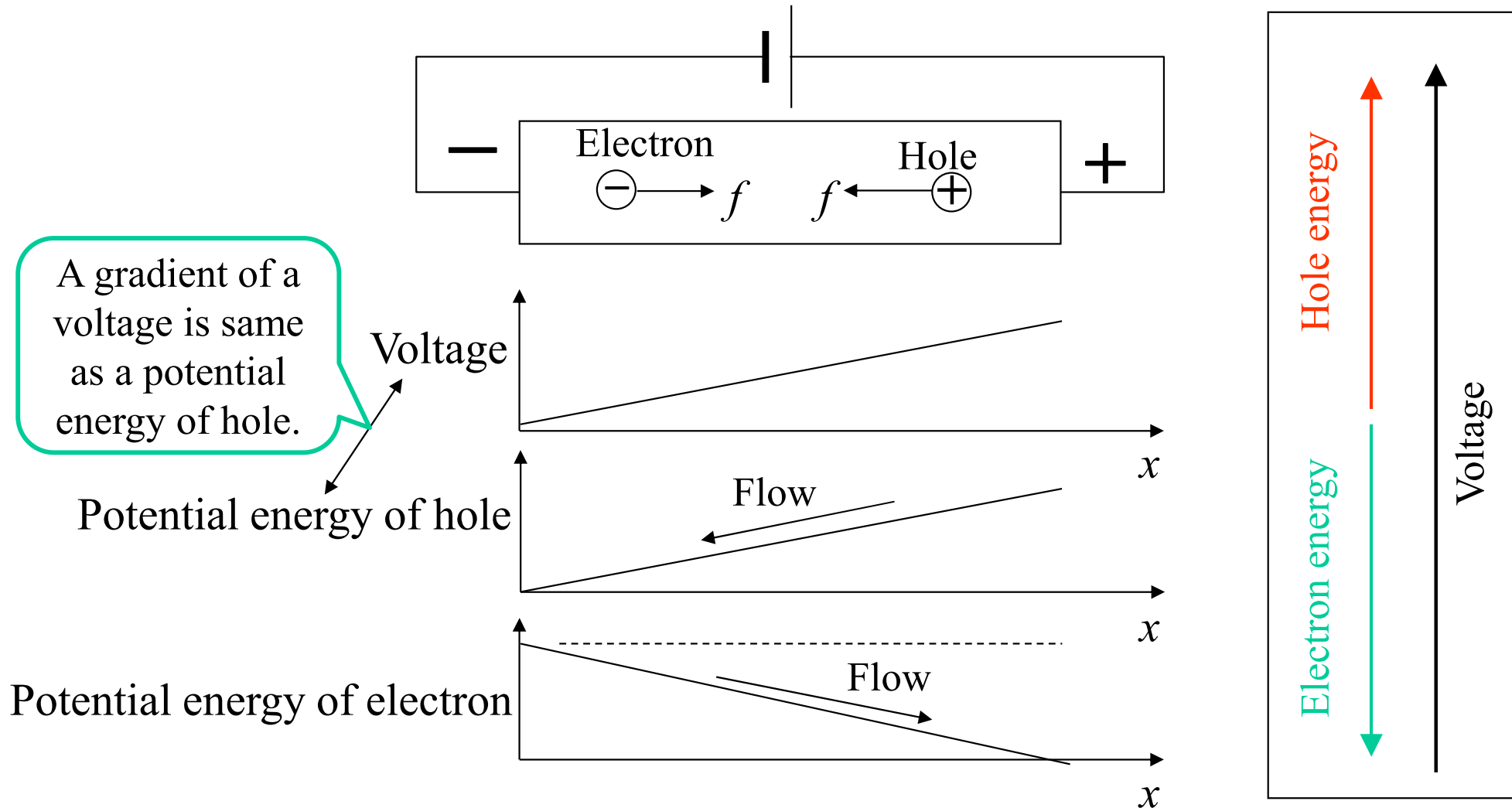
Note: The current does not flow through the pn junction because the electrostatic force and the diffusion of the carrier are balanced in the **equilibrium state**.

# 用語解説

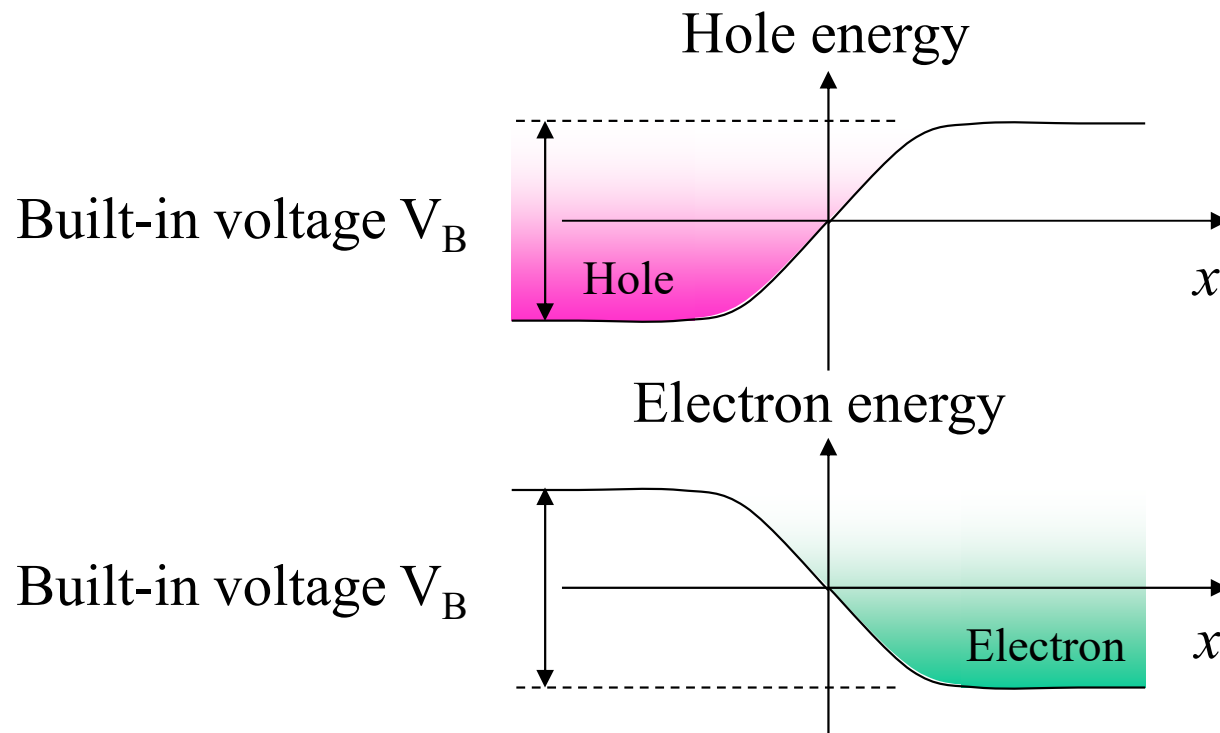
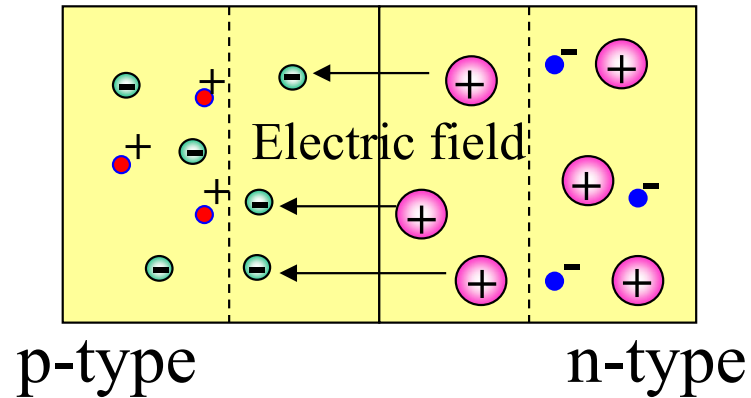
- Equilibrium state
  - 平衡状態(熱平衡状態)
  - 外部系とのエネルギーの授受が無い状態
- Steady state
  - 定常状態
  - 時間的変化が無い状態(交流電圧振幅や周波数が変化しない状態も含む)
- Transient state
  - 過渡状態
  - 時間的変化がある状態



# Potential energy of electron and hole

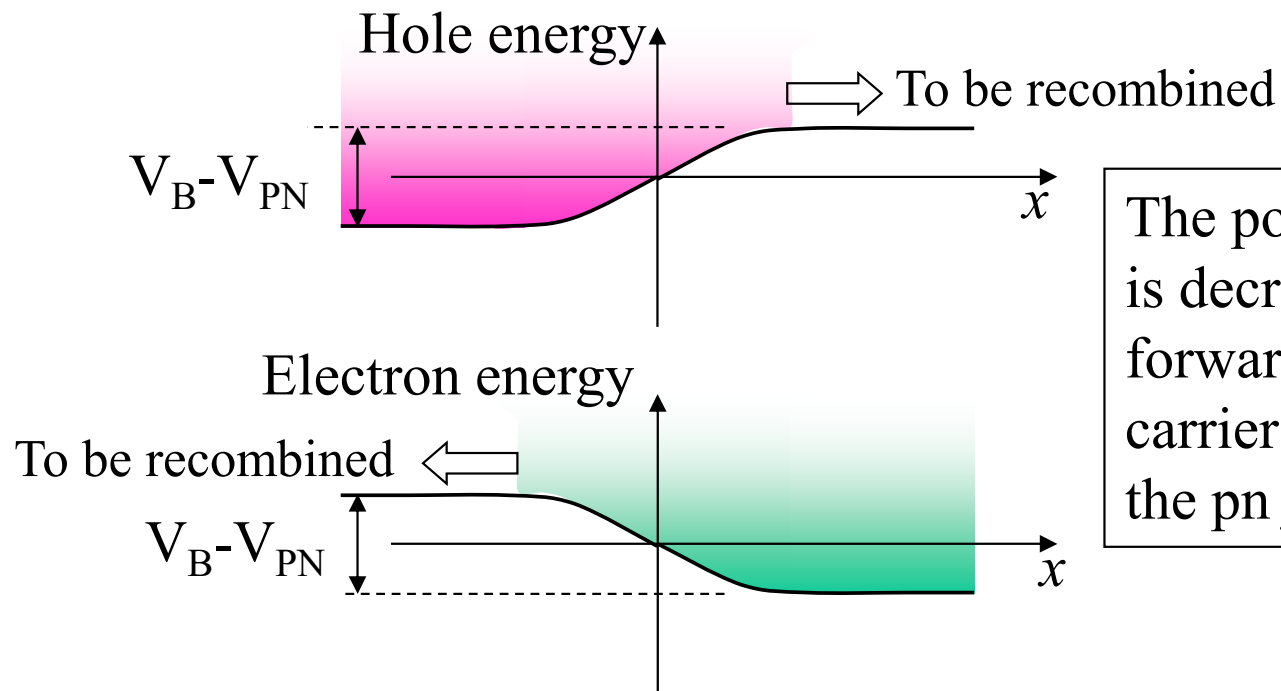
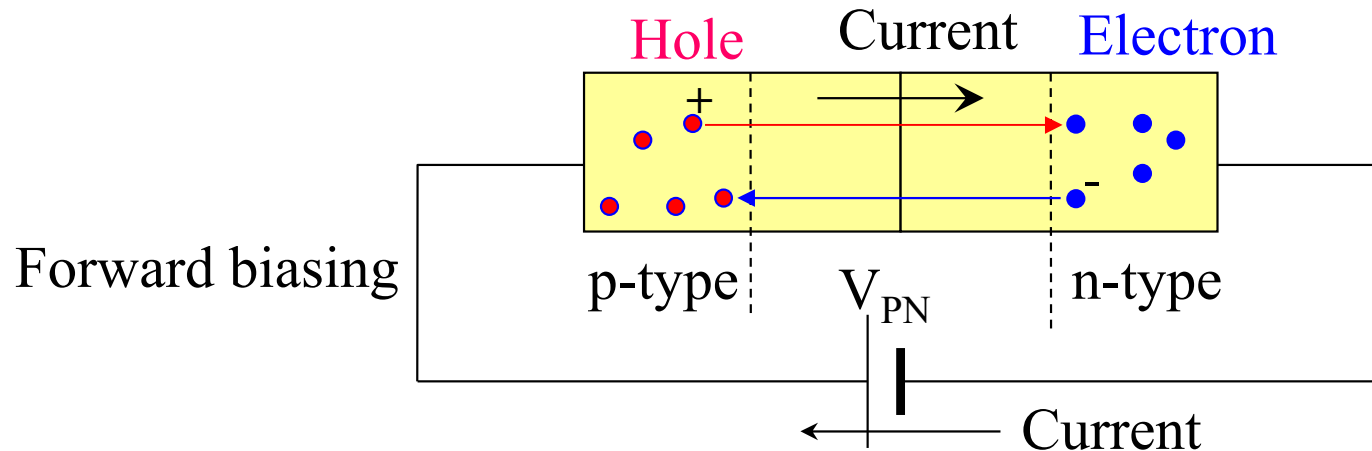


# Distribution of carriers



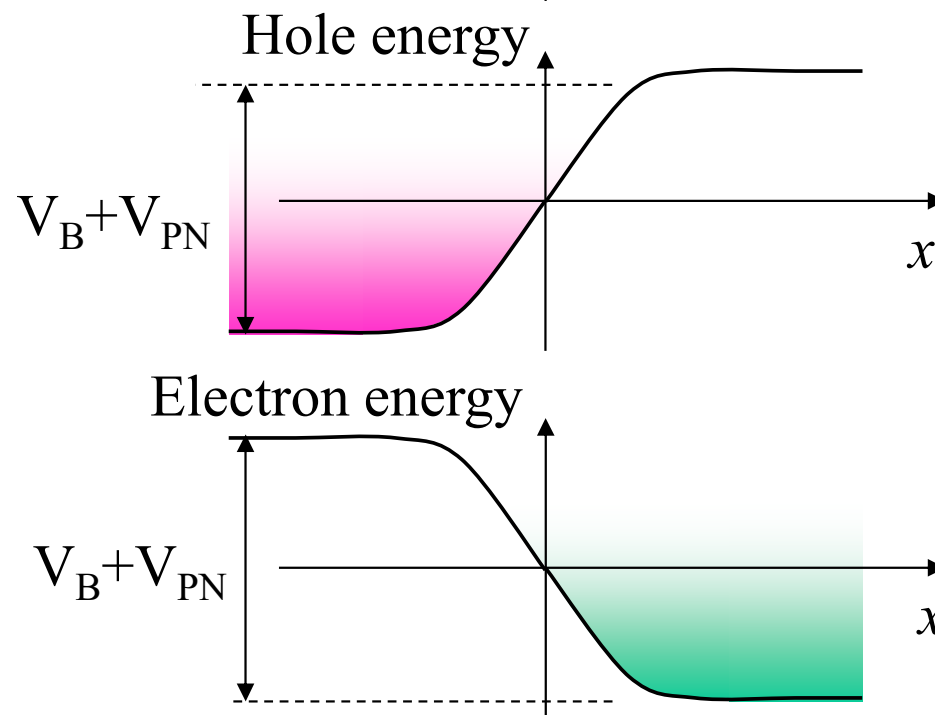
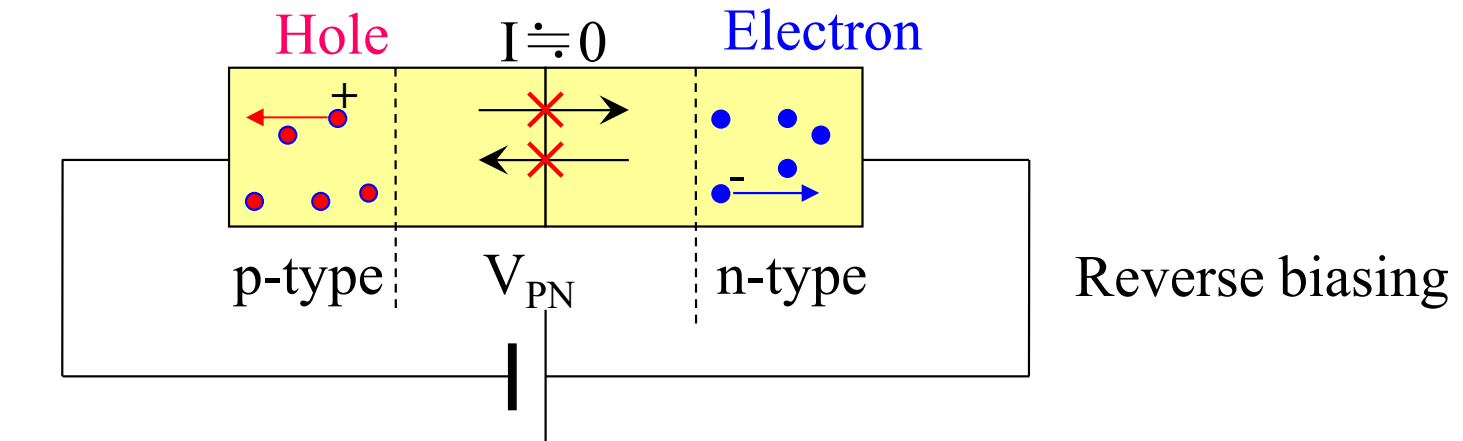
The carriers are gathered on the low-potential side.

# Forward biasing of pn junction



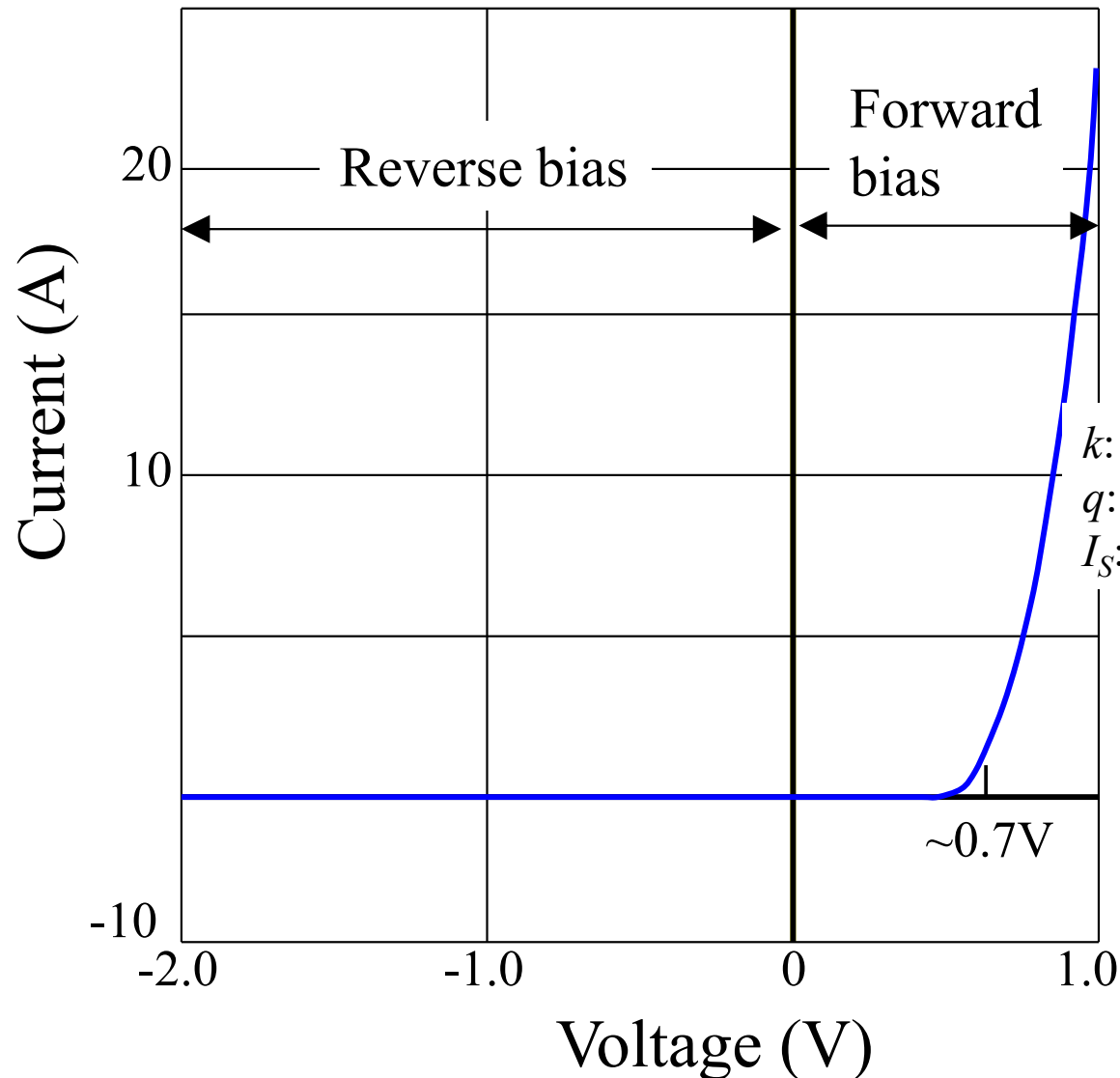
The potential barrier is decreased by the forward bias and the carriers flow through the pn junction.

# Reverse biasing of pn junction



The potential barrier is increased by the reverse bias and the carriers cannot flow through the pn junction.

# I-V characteristic of pn junction



Device model equation

$$I_{PN} = I_S \left( e^{\frac{q \cdot V_{PN}}{k \cdot T}} - 1 \right)$$

$k$ : Boltzmann's constant ( $1.380649 \cdot 10^{-23}$  J/K)

$q$ : Electronic charge ( $1.60 \cdot 10^{-19}$  coulomb)

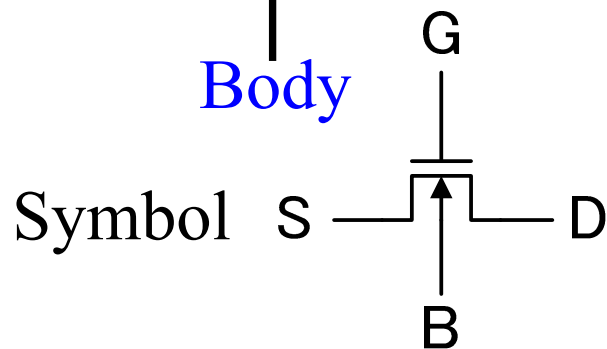
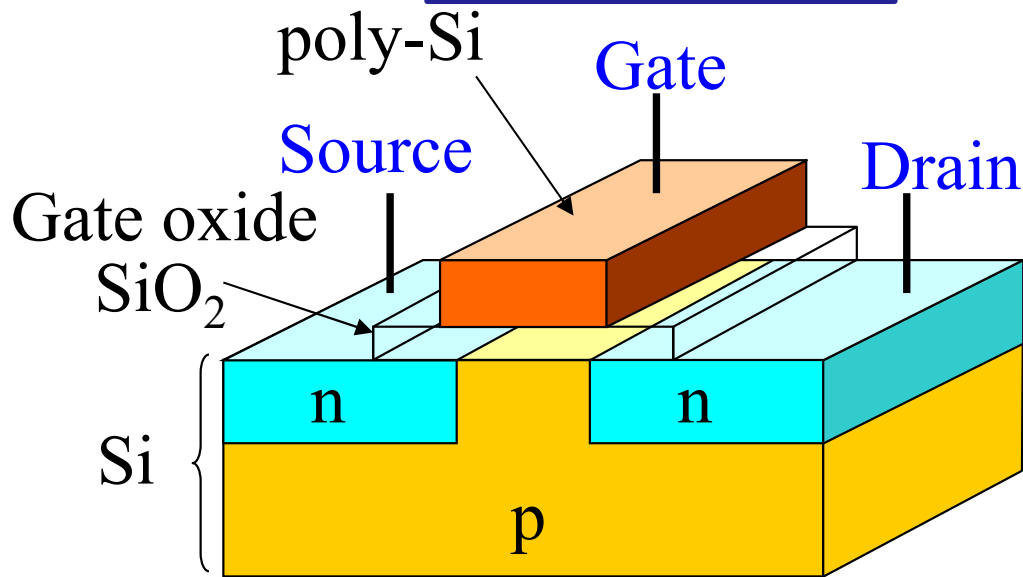
$I_S$ : Reverse saturation current (A)

## 2.1.2 Structure of MOSFET

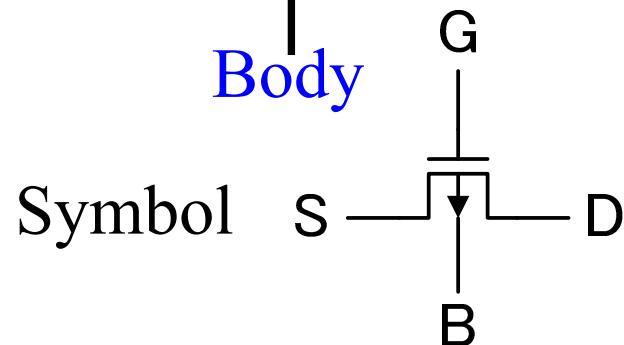
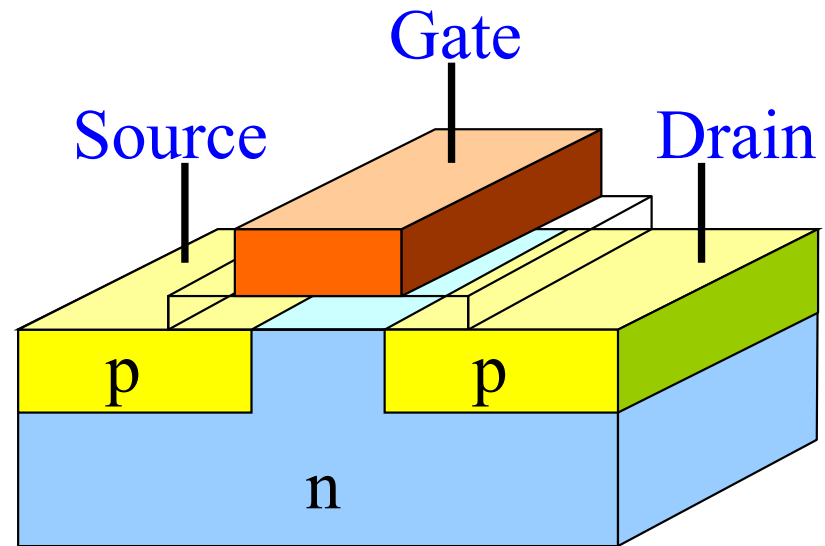
# Structure of MOSFET

MOSFET (Metal-Oxide-Semiconductor Field Effect Transistor)

n-ch MOSFET

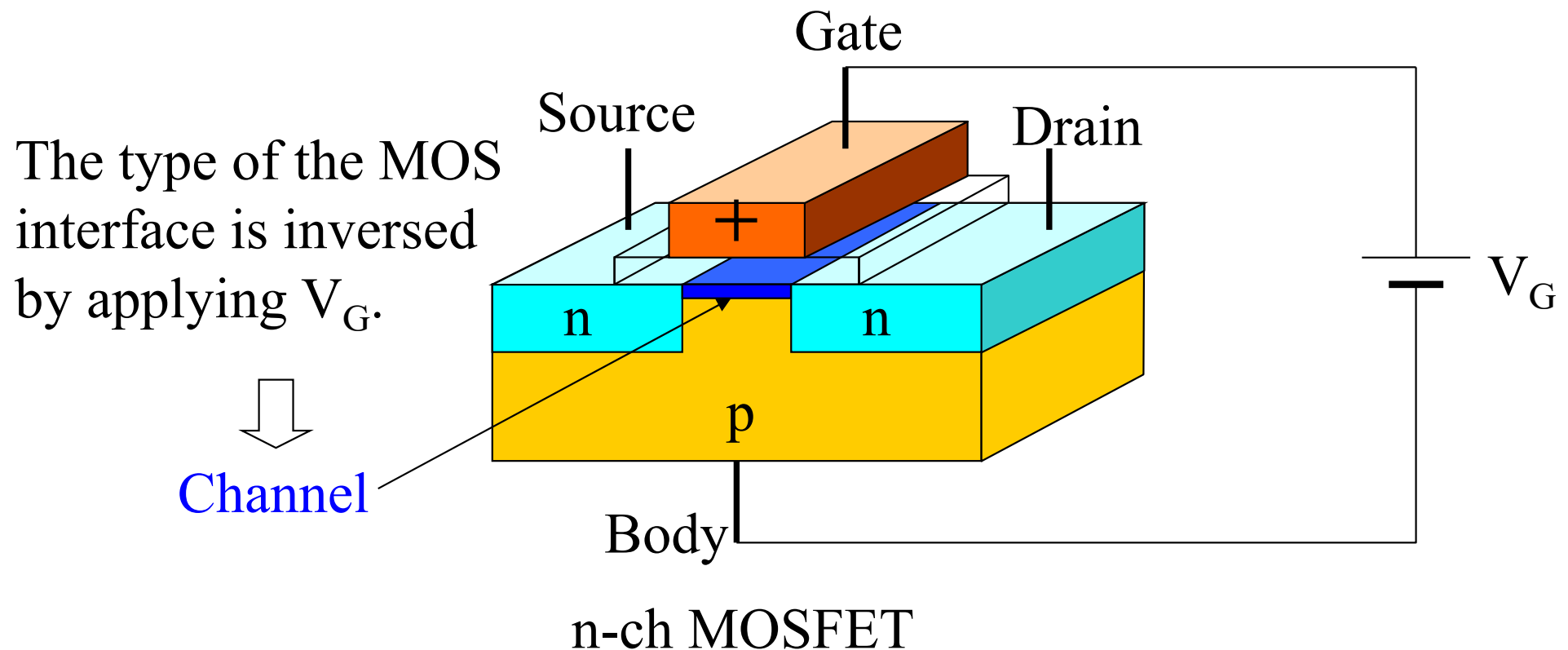


p-ch MOSFET



# Switching of n-ch MOSFET

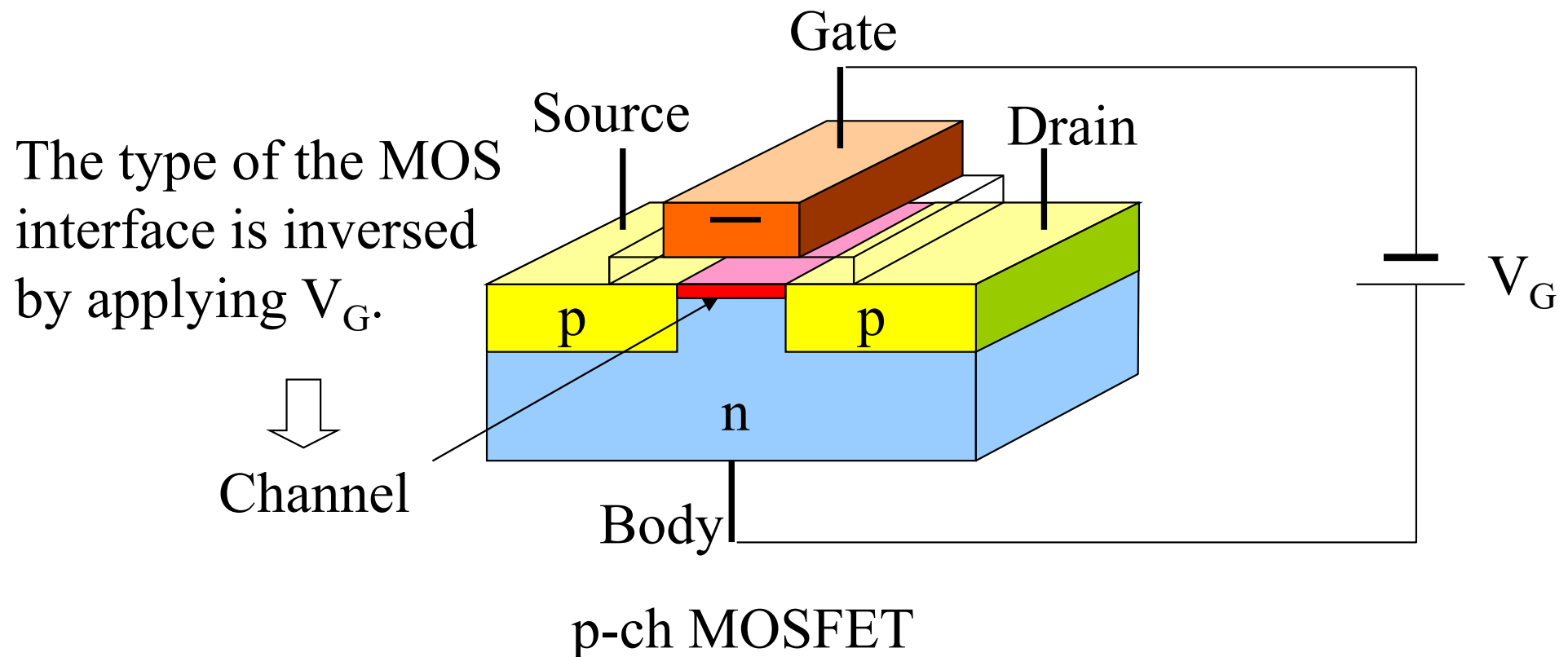
The free electrons are generated by lowering the potential at the  $\text{SiO}_2/\text{Si}$  interface (MOS interface) and the source and drain is electrically conducted.





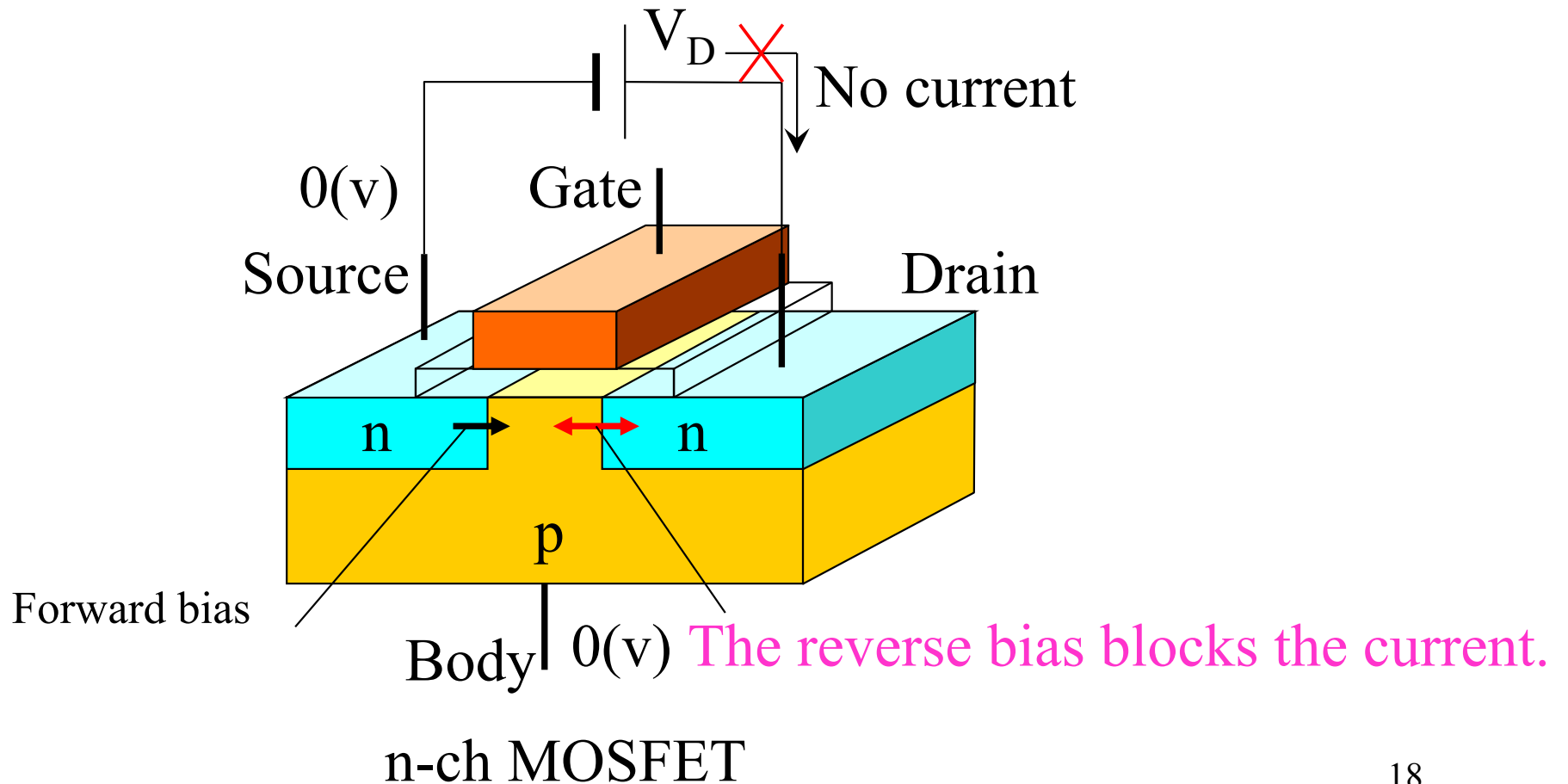
# Switching of p-ch MOSFET

The holes are generated by lowering the potential at the SiO<sub>2</sub>/Si interface (**MOS interface**) and the source and drain is electrically conducted.



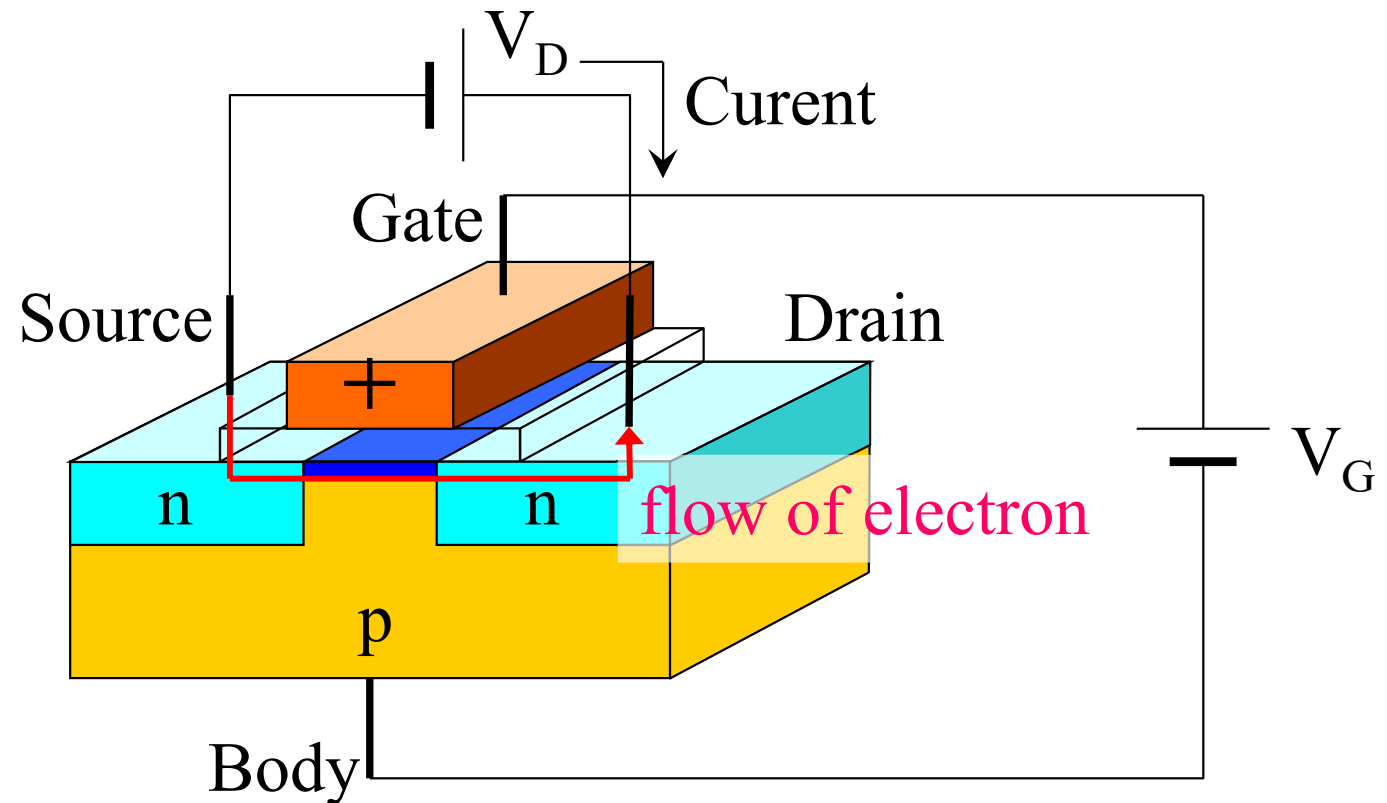
# OFF state of n-ch MOSFET

The current flow is blocked by the pn junction that is reverse-biased.



# ON state of n-ch MOSFET

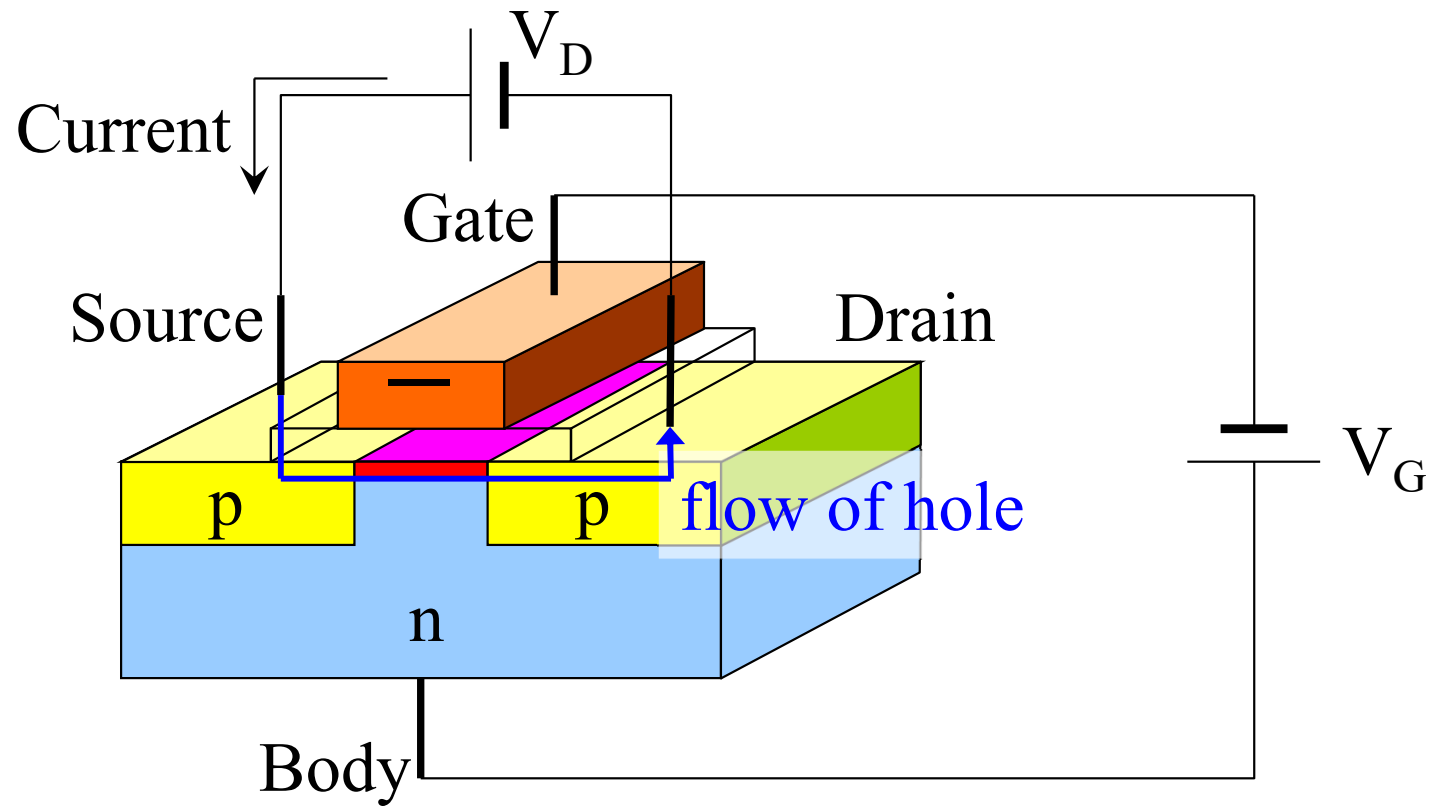
The electron flows through the channel at MOS interface.



n-ch MOSFET

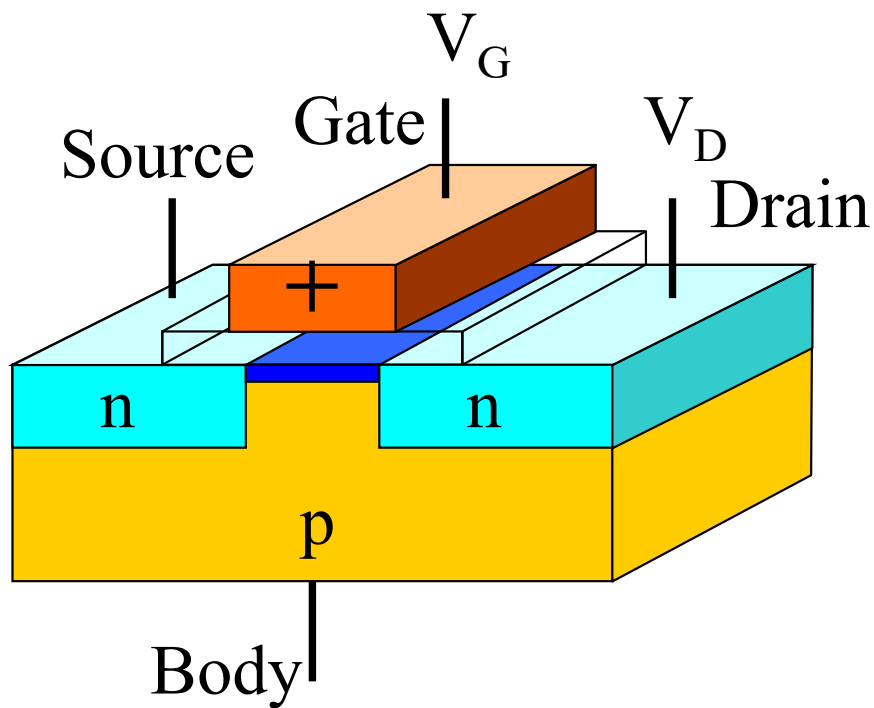
# ON state of p-ch MOSFET

The hole flows through the channel at MOS interface.

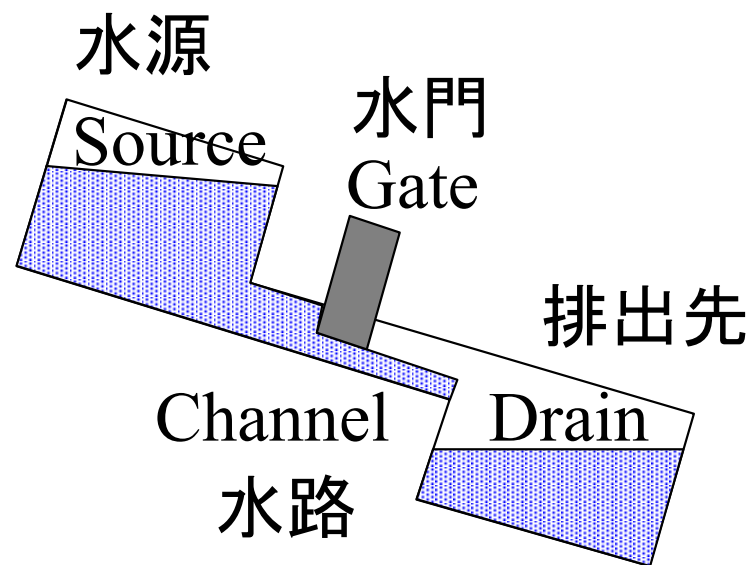


p-ch MOSFET

# The origin of the electrode name



## Analogy

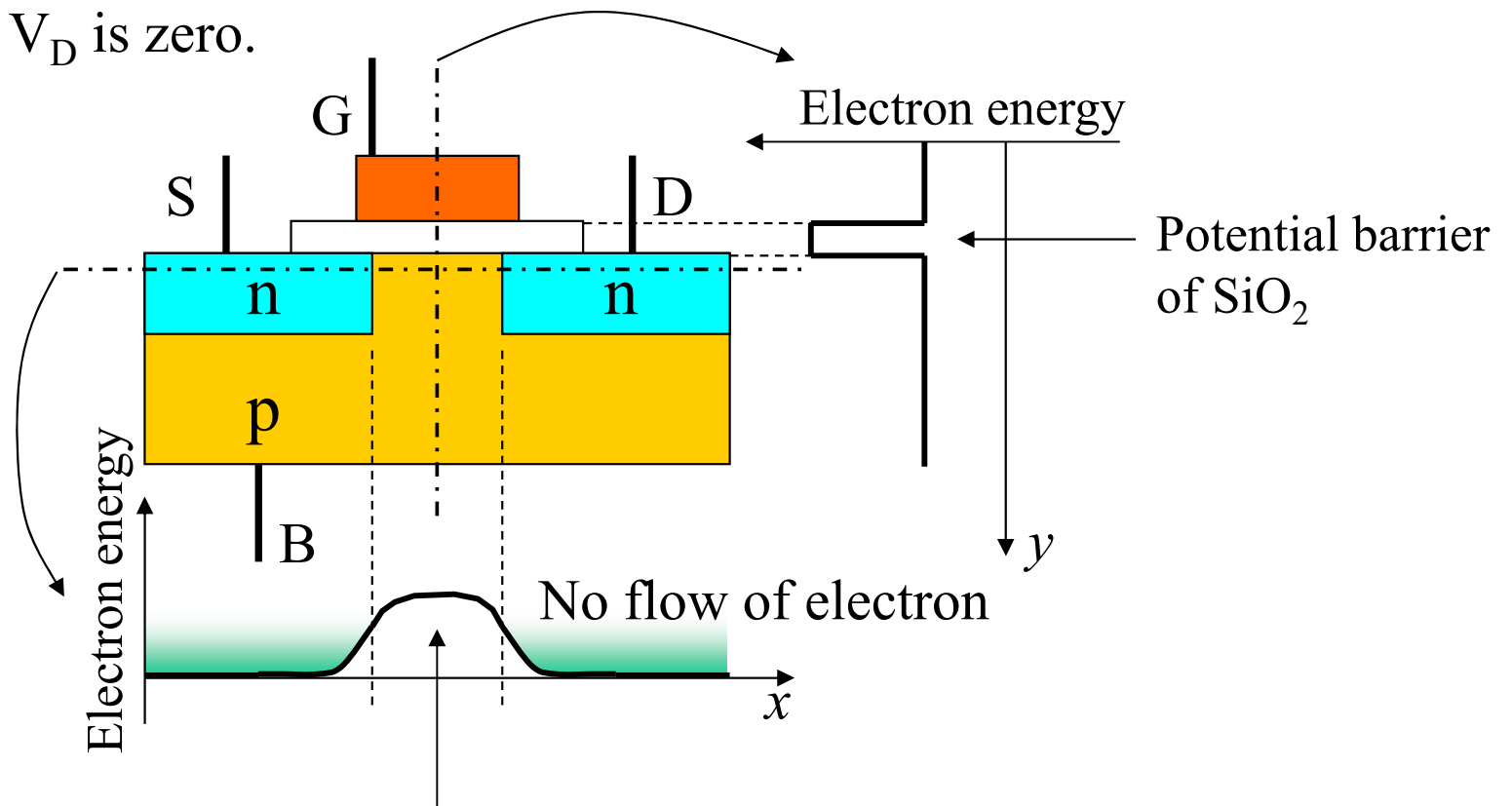


Note: Transistor = Trans-resistor

# Distribution of electron in MOSFET 1

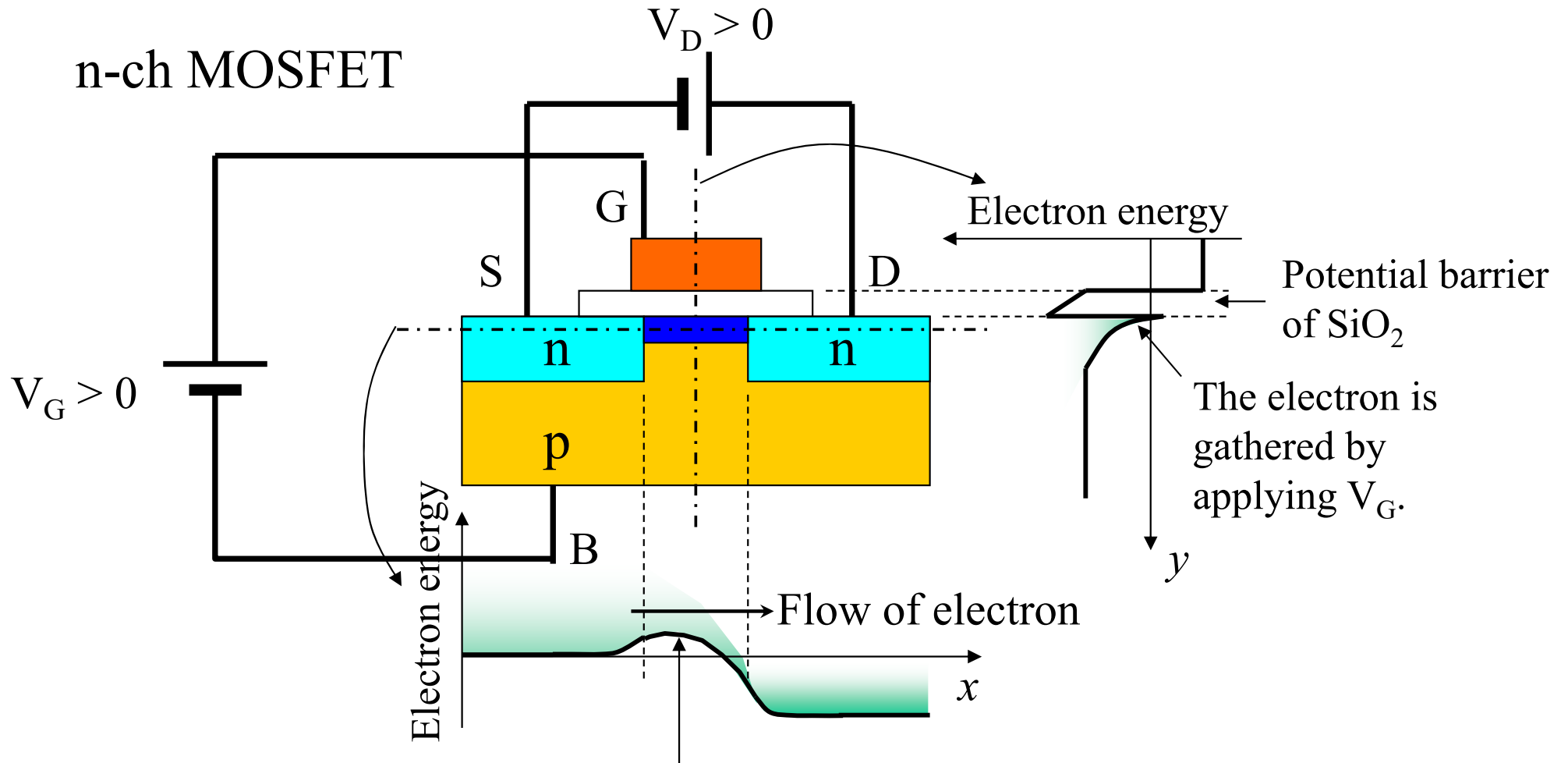
n-ch MOSFET

The  $V_G$  and the  $V_D$  is zero.



The potential barrier of p-type semiconductor is enough high and the electron cannot flow through the p-type region.

# Distribution of electron in MOSFET 2



The height of the potential barrier is decreased by applying  $V_G$  and the electron flows from the source to the drain.